TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOS III)

2SK2883

Chopper Regulator, DC–DC Converter and Motor Drive Applications

- Low drain-source ON resistance : $R_{DS (ON)} = 3.0 \Omega$ (typ.)
 - High forward transfer admittance $|Y_{fs}| = 2.6 \text{ S (typ.)}$
- Low leakage current : $I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 640 \ V)$
- Enhancement mode : V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	800	$(N \land $
Drain-gate voltage (R _{GS} = 20 kΩ)		V _{DGR}	800	V.
Gate-source voltage		V _{GSS}	±30	×
Drain current	DC (Note 1)	۱ _D) E	A
	Pulse (Note 1)	I _{DP}	9	Ā
Drain power dissipatio	n (Tc = 25°C)	PD	75	W
Single pulse avalanche energy (Note 2)		E _{AS}	300	mJ
Avalanche current		IAR	3	A
Repetitive avalanche energy (Note 3)		EAR) 7.5	mJ
Channel temperature		Tch	150 <	°C
Storage temperature range		T _{stg}	-55 to 150)°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	\$ymbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	1.67	°C / W
Thermal resistance, channel to ambient	R _{th (ch-a)}	83.5	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_DD = 90 V, T_ch = 25 $^\circ C$ (initial), L = 60.0 mH, R_G = 25 $\Omega,$ I_AR = 3 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.





Weight: 1.5 g (typ.)

Electrical Characteristics (Ta = 25°C)

Charao	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V	_	_	±10	μA
Gate-source br	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 640 V, V _{GS} = 0 V	$\overline{\lambda}$	_	100	μA
Drain-source br	reakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	800	1	—	V
Gate threshold	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	20)/-	4.0	V
Drain-source O	N resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 1.5 A		3.0	3.6	Ω
Forward transfe	r admittance	Y _{fs}	V _{DS} = 20 V, I _D = 1.5 A	0.65	2.6	_	S
Input capacitance		C _{iss}			750	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		10	_	pF
Output capacitance		C _{oss}		_	70	_	
Switching time	Rise time	tr	$V_{GS}^{10} V$ Π $I_{D} = 1.5 A$	- (5	\geq	
	Turn-on time	t _{on}		C X	55) _	20
	Fall time	t _f	$ \begin{bmatrix} \mathbf{G} \\ \mathbf{F} \\ \mathbf{F}$	\mathcal{T}	> 30	_	ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, t _w = 10 μ s) –	110	_	
Total gate charg plus gate-drain)		Qg		_	25	_	
Gate-source charge		Q _{gs}	V _{DD} ≈ 400 V, V _{GS} = 10 V, I _D = 3 A	—	13	—	nC
Gate-drain ("miller") Charge		Qgd		_	12	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)			-	_	3	А
Pulse drain reverse current (Note 1)	I _{DRP}	-			9	А
Forward voltage (diode)		I _{DR} = 3 Å, V _{GS} = 0 V	_		-1.9	V
Reverse recovery time	trr	I _{DR} = 3 A, V _{GS} = 0 V	_	900		ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 100 A / μs	_	6	_	μC

Marking



Note 4: A line under a Lot No. identifies the indication of product Labels. Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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